

# N-Channel PowerTrench<sup>®</sup> MOSFET 25 V, 40 A, 5.7 m $\Omega$

### Features

- Max r<sub>DS(on)</sub> = 5.7 mΩ at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 16.5 A
- State-of-the-art switching performance
- Lower output capacitance, gate resistance, and gate charge boost efficiency
- Shielded gate technology reduces switch node ringing and increases immunity to EMI and cross conduction
- RoHS Compliant

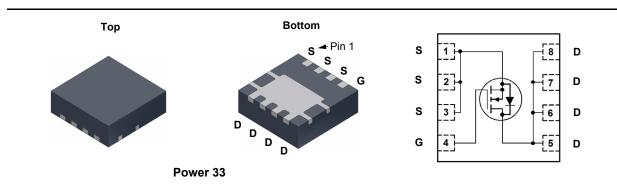


# **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$  fast switching speed and body diode reverse recovery performance.

### Applications

- High side switching for high end computing
- High power density DC-DC synchronous buck converter



# MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter	Ratings	Units		
V <sub>DS</sub>	Drain to Source Voltage	(Note 5)	25	V	
V <sub>GS</sub>	Gate to Source Voltage	(Note 4)	±12	V	
ID	Drain Current - Continuous (Package limited) T <sub>C</sub> = 25 °C		40		
	- Continuous (Silicon Limited) T <sub>C</sub> = 25 °C		59	•	
	- Continuous	(Note 1a)	16.5	Α	
	- Pulsed		60		
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	29	mJ	
P <sub>D</sub>	Power Dissipation $T_{\rm C}$ = 25 °C		26	14/	
	Power Dissipation $T_A = 25 \degree C$	(Note 1a)	2.4	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C	

## **Thermal Characteristics**

$R_{\thetaJC}$	Thermal Resistance, Junction to Case	T <sub>C</sub> = 25 °C		4.7	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	T <sub>A</sub> = 25 °C	(Note 1a)	53	0/11

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
08OD	FDMC8588	Power 33	13 "	12 mm	3000 units

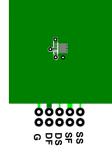
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Symbol	Parameter	Test Condition	s	Min	Тур	Max	Units	
Off Chara	octeristics							
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D$ = 250 $\mu$ A , $V_{GS}$ = 0 V		25			V	
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C			17		mV/°C	
DSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V				1	μA	
GSS	Gate to Source Leakage Current, Forward	d $V_{GS} = 12 V, V_{DS} = 0 V$				100	nA	
On Chara	cteristics							
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA		0.8	1.4	1.8	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu A$ , referenced t	o 25 °C		-4		mV/°C	
	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17 A			3.5	5.0	mΩ	
r <sub>DS(on)</sub>		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 16.5 A			4.3	5.7		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17 A,T <sub>J</sub>	= 125 °C		4.8	6.9		
ĴFS	Forward Transconductance	V <sub>DD</sub> = 5 V, I <sub>D</sub> = 16.5 A			85		S	
Dynamic C <sub>iss</sub>	Characteristics				1228	1720	pF	
C <sub>oss</sub>	Output Capacitance	— V <sub>DS</sub> = 13 V, V <sub>GS</sub> = 0 V, f = 1 MHz			441	620	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance				69	100	pF	
Rg	Gate Resistance			0.1	0.5	1.5	Ω	
	Characteristics							
d(on)	Turn-On Delay Time				8	16	ns	
r	Rise Time	$V_{DD}$ = 13 V, I <sub>D</sub> = 16.5A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω			3	10	ns	
d(off)	Turn-Off Delay Time				25	40	ns	
f	Fall Time				2	10	ns	
⊋ <sub>g(TOT)</sub>	Total Gate Charge at 4.5V	V <sub>DD</sub> = 13 V, I <sub>D</sub> = 16.5 A			12	17	nC	
2 <sub>gs</sub>	Total Gate Charge				3.0		nC	
2 <sub>gd</sub>	Gate to Drain "Miller" Charge				3.3		nC	
ວrain-Soເ	urce Diode Characteristics							
	Courses to Drain Diado Forguerd Maltana	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 2 A	(Note 2)		0.7	1.2	V	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 16.5 A	(Note 2)		0.8	1.2	V	
rr	Reverse Recovery Time	L = 16.5 A di/dt = 100 A	1.1.6		25		ns	
		<sub>E</sub> = 16.5 A. di/dt = 100 A/μs					1	

Q<sub>rr</sub>

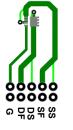
Notes: 1. R<sub>0JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

 $I_F = 16.5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ 



Reverse Recovery Charge

a. 53 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



b. 125 °C/W when mounted on a minimum pad of 2 oz copper

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2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

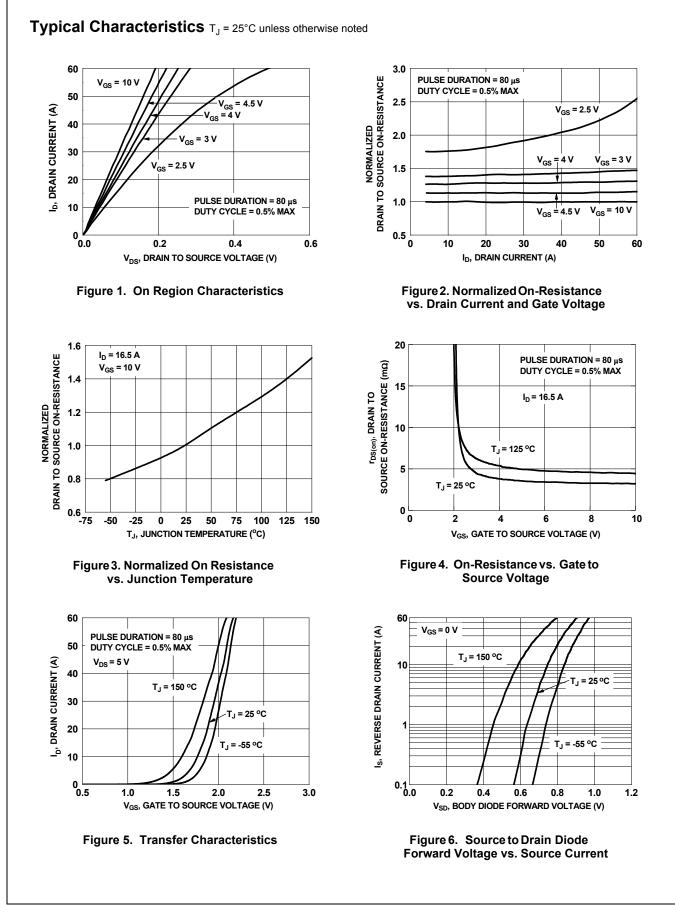
3. E<sub>AS</sub> of 29 mJ is based on starting T<sub>J</sub> = 25 °C, L = 1.2 mH, I<sub>AS</sub> = 7 A, V<sub>DD</sub> = 23 V, V<sub>GS</sub> = 10V. 100% tested at L = 0.1 mH, I<sub>AS</sub> = 16 A.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

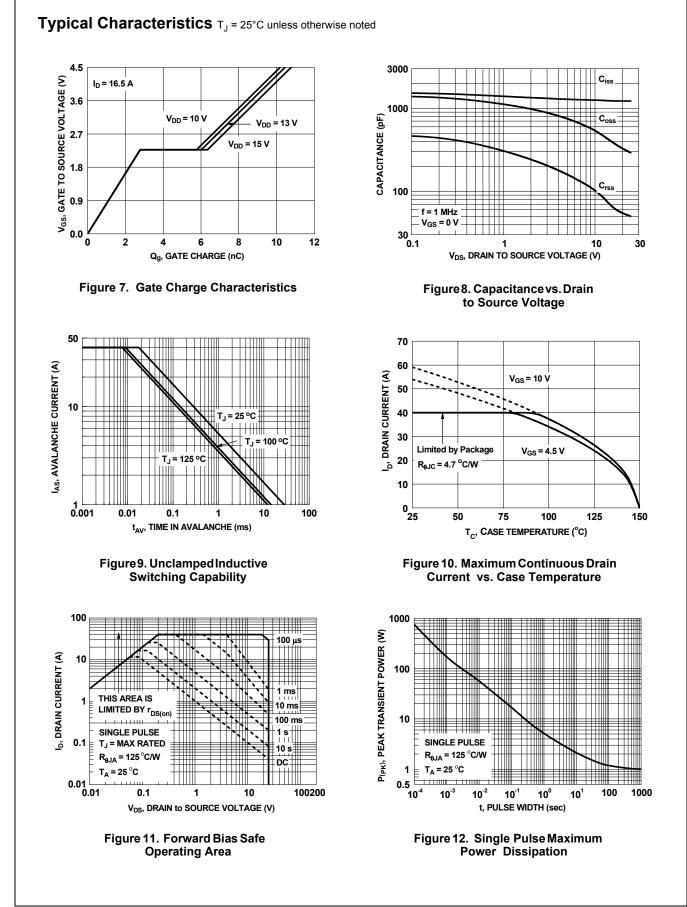
5. The continuous Vds rating is 25V; however, a pulse of 28 V peak voltage for no longer than 3ns duration at 500KHz frequency can be applied.

nC

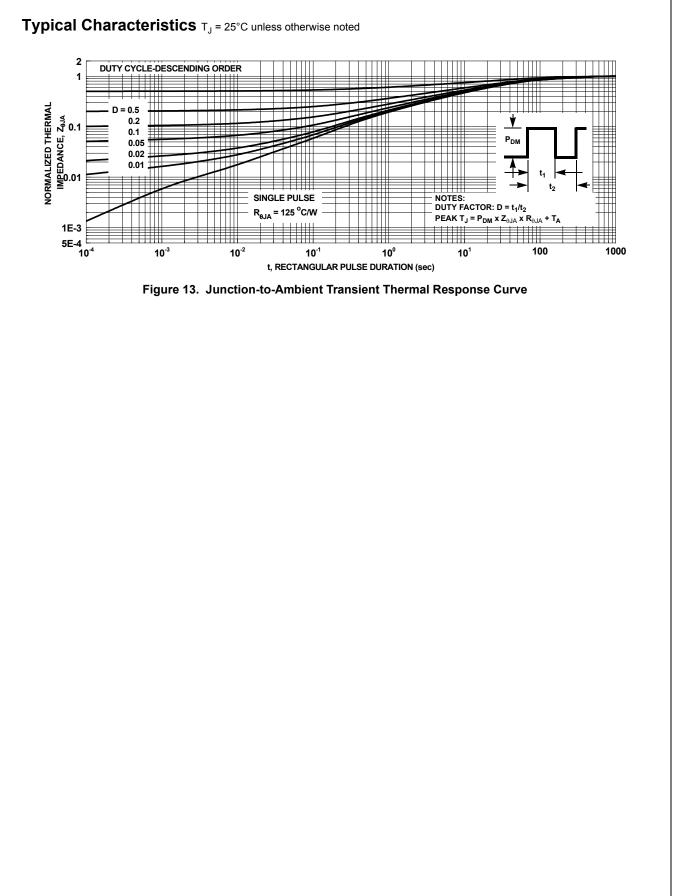




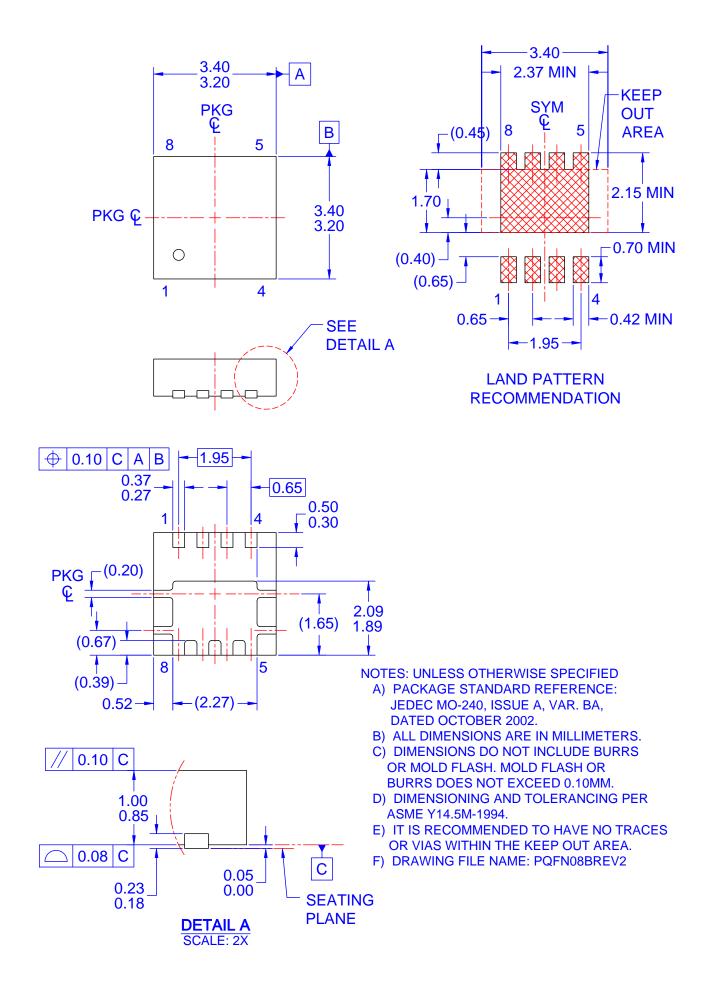




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FDMC8588 N-Channel PowerTrench<sup>®</sup> MOSFET





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